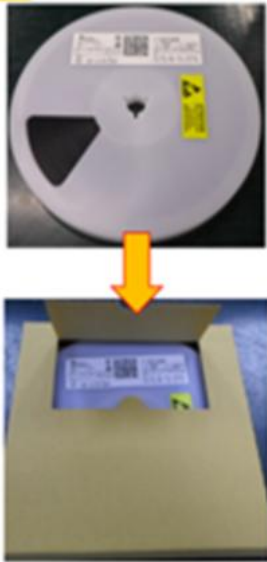
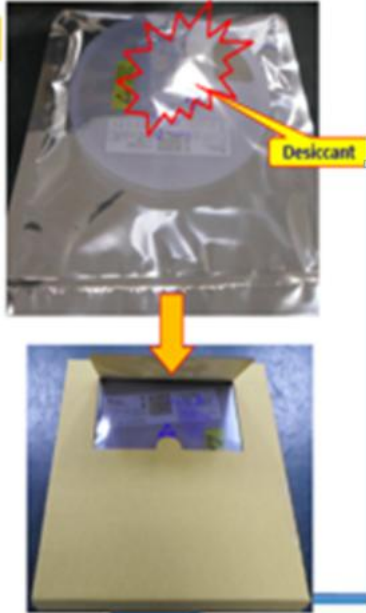


PCN Number:	20200520000.2		PCN Date:	June 8, 2020	
Title:	Packing material change for Select Device(s)				
Customer Contact:	PCN Manager	Dept:	Quality Services		
Proposed 1st Ship Date:	Dec. 8, 2020	Estimated Sample Availability:	Date provided at sample request		
Change Type:					
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design	<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Data Sheet	<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change	<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site	<input type="checkbox"/>	Wafer Fab Site
<input checked="" type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process	<input type="checkbox"/>	Wafer Fab Materials
				<input type="checkbox"/>	Wafer Fab Process
PCN Details					
Description of Change:					
This change notification is to announce the addition of using ESD sealed bag for the shipping reel before placing inside the Pizza Box for select devices listed in the "Product Affected" Section.					
	From		To		
Packing Description	Reel into Pizza Box		Reel in ESD Sealed Bag inside the Pizza Box		
Visual comparison					
Reason for Change:					
Prevent lead discoloration / oxidation leading to solderability Test failure					
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):					
None					
Anticipated impact on Material Declaration					
<input checked="" type="checkbox"/>	No Impact to the Material Declaration	<input type="checkbox"/>	Material Declarations or Product Content reports are driven from production data and will be available following the production release. Upon production release the revised reports can be obtained at the site link below http://www.ti.com/quality/docs/materialcontentsearch.tsp		
Changes to product identification resulting from this PCN:					

None			
Product Affected:			
DRV5013AEDDBZJQ1	DRV5023AJEDBZRQ1	DRV5053CAEDBZTQ1	DRV5053PAQDBZRQ1
DRV5013AEDDBZRQ1	DRV5023AJEDBZTQ1	DRV5053CAQDBZRQ1	DRV5053PAQDBZTQ1
DRV5013AEDDBZTQ1	DRV5023AJQDBZRQ1	DRV5053CAQDBZTQ1	DRV5053RAEDBZRQ1
DRV5013ADQDBZRQ1	DRV5023AJQDBZTQ1	DRV5053EAEDBZRQ1	DRV5053RAEDBZTQ1
DRV5013ADQDBZTQ1	DRV5023BIEDBZRQ1	DRV5053EAEDBZTQ1	DRV5053RAQDBZRQ1
DRV5013AGEDBZRQ1	DRV5023BIEDBZTQ1	DRV5053EAQDBZRQ1	DRV5053RAQDBZTQ1
DRV5013AGEDBZTQ1	DRV5023BIQDBZRQ1	DRV5053EAQDBZTQ1	DRV5053VAEDBZRQ1
DRV5013AGQDBZRQ1	DRV5023BIQDBZTQ1	DRV5053OAEDBZRQ1	DRV5053VAEDBZTQ1
DRV5013AGQDBZTQ1	DRV5033AJEDBZRQ1	DRV5053OAEDBZTQ1	DRV5053VAQDBZRQ1
DRV5013BCEDBZRQ1	DRV5033AJEDBZTQ1	DRV5053OAQDBZRQ1	DRV5053VAQDBZTQ1
DRV5013BCEDBZTQ1	DRV5033AJQDBZRQ1	DRV5053OAQDBZTQ1	SN74AUP2G00QDCURQ1
DRV5013BCQDBZRQ1	DRV5033AJQDBZTQ1	DRV5053PAEDBZRQ1	TPD2E0011DRLRQ1
DRV5013BCQDBZTQ1	DRV5053CAEDBZRQ1	DRV5053PAEDBZTQ1	

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

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